DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name,

I believe I am the original, first, and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

SURFACE MOUNT PACKAGE FOR LINEAR ARRAY SENSORS

the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

having a filing date before	e that of the appli	cation on which pri-	ority is claimed:
Prior Foreign Application(s):		Priority Claimed
(Number)	(Country)	(Day/Month/Year)	Yes No
I hereby claim the benefit States application(s) lists claims of this application in the manner provided by t I acknowledge the duty to d application as defined in T between the filing date of this application date of the state of the stat	ed below and, insofa is not disclosed : the first paragraph isclose information title 37, Code of Fea the prior application	ar as the subject mat in the prior United S of Title 35, United material to the pat deral Regulations, §1	ter of each of the States application States Code, §112, entability of this 56 which occurred
(Application Serial #)	(Filing Date	.)	(Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint Theodore E. Galanthay, Reg. No. 24,122; Lisa K. Jorgenson, Reg. No. 34,845; Robert D. McCutcheon, Reg. No. 38,717; Mario Donato, Reg. No. 37,817; James E. Bradley, Reg. 27,536; Charles D. Gunter, Jr., Reg. No. 29,386; Andrew J. Dillon, Reg. No. 29,634; Jack V. Musgrove, Reg. No. 31,986; Daniel E. Venglarik, Reg. No. 39,409; Brian F. Russell, Reg. No. 40,796; Matthew W. Baca, Reg. No. 42,277; and Antony P. Ng, Reg. No. 43,427 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office in connection therewith.

Please send all correspondence to:

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Inventor's Signature Full Name of Inventor Date of Signature:	, , , , , , , , , , , , , , , , , , , ,
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